

SGM817xQ Microprocessor Supervisory Circuit with Watchdog Timer and Manual Reset for Automotive Applications

GENERAL DESCRIPTION

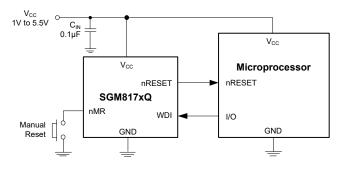
The SGM817xQ is a complete microprocessor supervisory device which combines reset, watchdog and manual reset functions in a SOT-23-5 package. System reliability is significantly improved by such integration compared to the designs with individual ICs or discrete components. The SGM817xQ also features an excellent transient immunity to ignore fast V_{CC} transients.

This device has an active-low push-pull reset output (nRESET) that is activated by a logic low on the manual reset input (nMR), a watchdog expiry event or due to a low V_{CC} voltage. The nRESET output can still be in the correct logic state even if V_{CC} is 1V. The SGM817xQ is offered in four fixed V_{CC} reset threshold voltages.

The device is AEC-Q100 qualified (Automotive Electronics Council (AEC) standard Q100 Grade 1) and it is suitable for automotive applications.

The SGM817xQ is available in a Green SOT-23-5 package. It operates over an ambient temperature range of -40°C to +125°C.

TYPICAL APPLICATION





FEATURES

• AEC-Q100 Qualified for Automotive Applications Device Temperature Grade 1

 $T_A = -40^{\circ}C \text{ to } +125^{\circ}C$

- Ultra-Low Supply Current: 0.64µA (TYP)
- Precision Supply-Voltage Monitor
 - 4.66V for SGM817-LQ
 - 3.10V for SGM817-TQ
 - 2.95V for SGM817-SQ
 - 2.64V for SGM817-RQ
- Guaranteed nRESET Valid at V_{cc} = 1V
- Push-Pull nRESET Output
- Reset Pulse Width: 25ms (TYP)
- Debounced TTL/CMOS-Compatible
- Manual Reset Input
- Watchdog Timer with 200ms (TYP) Timeout
- Fully Specified over Temperature
- Power-Supply Transient Immunity
- Without External Components
- -40°C to +125°C Operating Temperature Range
- Available in a Green SOT-23-5 Package

APPLICATIONS

Automotive Equipment Computers Portable Equipment Intelligent Instruments Critical µP Power Monitoring



Microprocessor Supervisory Circuit with Watchdog Timer and Manual Reset for Automotive Applications

PACKAGE/ORDERING INFORMATION

MODEL	RESET THRESHOLD (V)	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM817-LQ	4.66	SOT-23-5	-40°C to +125°C	SGM817-LQN5G/TR	14W XXXXX	Tape and Reel, 3000
SGM817-TQ	3.10	SOT-23-5	-40°C to +125°C	SGM817-TQN5G/TR	14X XXXXX	Tape and Reel, 3000
SGM817-SQ	2.95	SOT-23-5	-40°C to +125°C	SGM817-SQN5G/TR	0U1 XXXXX	Tape and Reel, 3000
SGM817-RQ	2.64	SOT-23-5	-40°C to +125°C	SGM817-RQN5G/TR	14Y XXXXX	Tape and Reel, 3000

MARKING INFORMATION

NOTE: XXXXX = Date Code, Trace Code and Vendor Code.



SGM817xQ



—— Trace Code

— Date Code - Year

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

Terminal Voltage (with Respect to GND)

V _{CC}	0.3V to 6.0V
All Other Inputs	0.3V to V _{CC} + 0.3V
Input Current	
V _{CC}	20mA
GND	20mA
Output Current	
All Outputs	20mA
Package Thermal Resistance	
SOT-23-5, θ _{JA}	183°C/W
SOT-23-5, θ _{JB}	48.5°C/W
SOT-23-5, θ _{JC}	70.5°C/W
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (Soldering, 10s)	+260°C
ESD Susceptibility	
HBM	4000V
CDM	1000V

RECOMMENDED OPERATING CONDITIONS

Supply Voltage Range, V _{CC}	1V to 5.5V
Operating Ambient Temperature Range40)°C to +125℃

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

ESD SENSITIVITY CAUTION

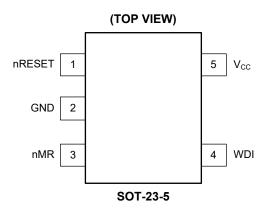
This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.



PIN CONFIGURATION



PIN DESCRIPTION

PIN	NAME	I/O	FUNCTION
1	nRESET	0	Active-Low Reset Output Pin. It delivers a 25ms (TYP) low pulse when activated. nRESET remains low if V_{CC} is below the reset threshold or nMR is logic low. It remains low for 25ms after any of the following events: V_{CC} rises above the reset threshold, a watchdog expiry triggers a reset, or the nMR input goes from low to high.
2	GND	G	Ground.
3	nMR	I	Manual Reset Input Pin. nRESET keeps low when nMR is low. When nMR is high, nRESET becomes high after a 25ms timeout period. It is an active-low reset input with an internal $65k\Omega$ pull-up resistor. nMR can be driven by a CMOS/TTL logic or by a switch shorting to GND. If not used, leave it open or connect it to V _{CC} .
4	WDI	I	Watchdog Input Pin. If the high or low state of WDI exceeds the watchdog timeout period, the internal watchdog timer is expired and a reset is triggered. The internal watchdog timer is clear while a reset is asserted. The timer is also cleared if the WDI input is changed (on rising or falling edges). The watchdog feature is disabled if the WDI is left open or if it is connected to a three-stated buffer output.
5	V _{CC}	I	Supply Voltage Pin.

NOTE: I = input, O = output, G = ground.



Microprocessor Supervisory Circuit with Watchdog Timer SGM817xQ and Manual Reset for Automotive Applications

ELECTRICAL CHARACTERISTICS

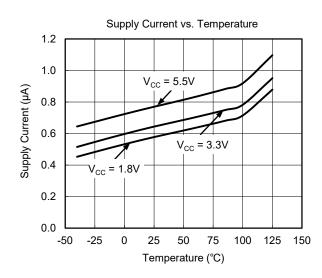
(V_{CC} = 4.76V to 5.5V for SGM817-LQ, V_{CC} = 3.18V to 5.5V for SGM817-TQ, V_{CC} = 3.03V to 5.5V for SGM817-SQ, V_{CC} = 2.72V to 5.5V for SGM817-RQ, T_A = -40°C to +125°C, typical values are at T_A = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
Operating Voltage Range	V _{cc}			1		5.5	V	
Summer Current		V _{CC} = 3.3V		0.64	1.60			
Supply Current	I _{SUPPLY}	V _{cc} = 5.5V		0.77	1.80	μΑ		
		SCM917 L O	T _A = +25°C	4.57	4.66	4.75		
		SGM817-LQ	T _A = -40°C to +125°C	4.56	4.66	4.76		
			T _A = +25°C	3.03	3.10	3.17		
	V	SGM817-TQ	$T_{A} = -40^{\circ}C \text{ to } +125^{\circ}C$	3.02	3.10	3.18	v	
nRESET Threshold	V _{nRST}	SCM917 SO	T _A = +25°C	2.88	2.95	3.02]	
		SGM817-SQ	T _A = -40°C to +125°C	2.87	2.95	3.03	1	
		SOM047 DO	T _A = +25°C	2.58	2.64	2.70	1	
		SGM817-RQ	T _A = -40°C to +125°C	2.56	2.64	2.72	1	
		SGM817-LQ			21			
	N	SGM817-TQ			15			
nRESET Threshold Hysteresis	V _{HYS}	SGM817-SQ		14		- mV		
		SGM817-RQ			13		1	
nRESET Threshold Temperature Coefficient		$T_A = -40^{\circ}C$ to +12		20		ppm/°C		
nRESET Timeout Period	t _{RP}			15	25	37.5	ms	
	V _{он}	V _{CC} ≥ 3.15V, I _{SOUF}	$0.8 \times V_{CC}$					
		$V_{CC} \ge 4.75V, I_{SOU}$	$0.8 \times V_{CC}$			0.3 0.3 0.3 0.4		
	V _{OL}	$V_{CC} \ge 1.0V, I_{SINK} =$			0.3			
nRESET Output Voltage		$V_{CC} \ge 1.2V, I_{SINK} =$			0.3			
		$V_{CC} \ge 2.55V, I_{SINK}$			0.3			
		$V_{CC} \ge 4.25V, I_{SINK}$			0.4			
V _{CC} to Reset Delay	t _{RD}	V_{nRST} - V_{CC} = 100	mV		90		μs	
Watchdog Timeout Period	t _{wD}			120	200	340	ms	
WDI Pulse Width	t _{WP}	$V_{IL} = 0V, V_{IH} = V_{CI}$	90			ns		
WDI Input Threshold	VIL	$V_{nRST(MAX)} < V_{CC} < 5.5V$				0.6	V	
	VIH	$V_{nRST(MAX)} < V_{CC} <$	5.5V	$0.7 \times V_{CC}$			V	
WDI Input Current		WDI = V _{CC} , time average			0.01	0.5		
		WDI = 0V, time average		-0.5	-0.01		μA	
nMR Input Voltage	VIL					0.6	V	
	VIH			$0.7 \times V_{CC}$			v	
nMR Pulse Width	t _{MR}			300			ns	
nMR Noise Immunity (Pulse Width with No Reset)					130		ns	
nMR to nRESET Out Delay	t _{MD}				550	ns		
nMR Pull-Up Resistance (Internal)				40	65	86	kΩ	

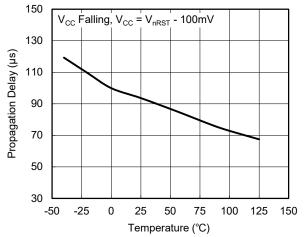


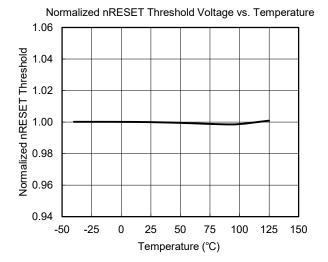
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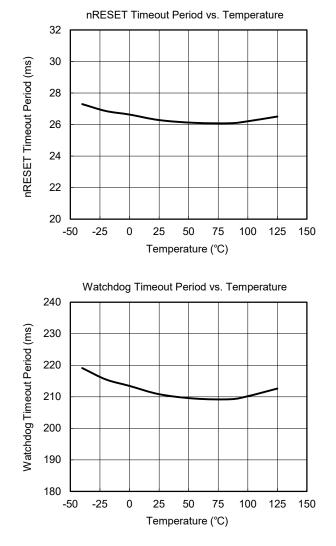
TYPICAL PERFORMANCE CHARACTERISTICS

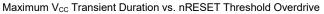


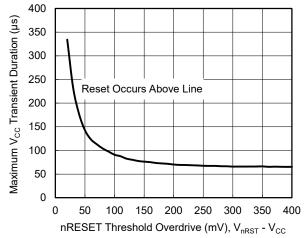








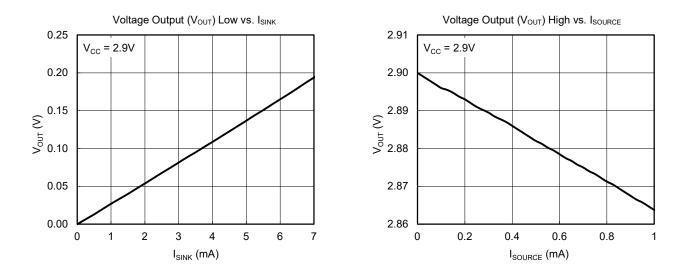




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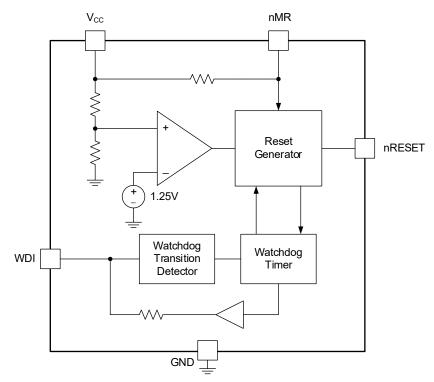
Microprocessor Supervisory Circuit with Watchdog Timer and Manual Reset for Automotive Applications

TYPICAL PERFORMANCE CHARACTERISTICS (continued)



FUNCTIONAL BLOCK DIAGRAM

SGM817xQ





DETAILED DESCRIPTION

nRESET Output

The reset input of a microprocessor (μ P) initiates it to a known state. The SGM817xQ supervisory circuit asserts a reset to the supervised μ P to prevent the code-execution errors that may occur due to power-up, power-down, brownout conditions or other transients. The nRESET output is still in the correct logic state even if V_{CC} is lower than 1V. During power-up, when V_{CC} exceeds the rising threshold voltage (V_{nRST} + V_{HYS}), an internal timer keeps nRESET in low state for the reset timeout period (t_{RP}) before nRESET returns to the high state (Figure 3).

If V_{CC} drops below the falling threshold voltage (V_{nRST}) (a brownout condition occurs), a reset is asserted and nRESET goes low. In general, nRESET remains low for the t_{RP} (25ms, TYP) period every time after the last event. So, if during the low period of nRESET, V_{CC} goes up and dips below V_{nRST} again, the internal timer will restart for a new t_{RP} period. The nRESET output can source and sink current.

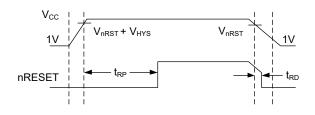


Figure 3. nRESET Timing Diagram

Manual Reset Input

Many µP-based products need manual-reset capability to let the operator or an external logic reset the µP. For the SGM817xQ, applying a logic low to the nMR input asserts a reset (nRESET = low). nRESET remains low while nMR is low, and will stay low for the t_{RP} (25ms, TYP) period after nMR returns to high state. The nMR input is internally pulled up by a $65k\Omega$ resistor and can be left floating if not used. It can be driven by a CMOS/TTL logic or by a switch shorting to GND. A normally open momentary switch connected between nMR and GND pins can be used as a manual reset. Switch debouncing is not needed. However, if long cables are used to drive the nMR input or if the environment is noisy, connect a 0.1µF capacitor between nMR and GND to immune the additional noise.

Watchdog Input

The internal watchdog circuit monitors the μ P's activity by checking the WDI input. If the μ P does not toggle the WDI within the watchdog t_{WD} (200ms, TYP) period, nRESET will send a low pulse to reset the μ P. So, the code should be written such that successive toggles on WDI occur in periods not longer than the lowest t_{WD} time to reset the internal watchdog timer and prevent μ P reset when the code is running normally. The watchdog timer is cleared by either toggling WDI or by a pulse with a duration as short as 90ns. While the reset is asserted and nRESET is low, the watchdog timer is cleared and timer does not count. It starts counting when the reset is released and nRESET goes high (Figure 4).

To disable the watchdog function, leave the WDI pin open. If WDI is driven by a 3-state buffer, set it to the Hi-Z state. In this case, the buffer leakage current should not exceed 10μ A. The maximum capacitance seen on the WDI pin should be less than 200pF to ensure that watchdog remains disabled. The watchdog input is internally oscillating when it is left open to clear the watchdog timer and prevent it from generating a reset. It is driven low during the first 7/8 of the watchdog timeout period and driven high in the last 1/8 of that. For example, if WDI input is open and the watchdog timeout is 200ms, the watchdog timer will automatically clear every 175ms and reset will not occur.

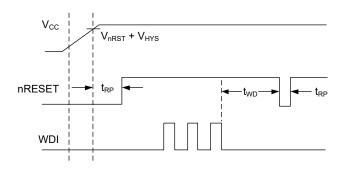


Figure 4. Watchdog Timing Relationship



APPLICATION INFORMATION

Using SGM817xQ with Microprocessors with Bidirectional Reset Pins

Some microprocessors can internally force their reset pins low to assert a reset (bidirectional reset pins). The low pull-up current of the SGM817xQ allows using of them along with the microprocessors with bidirectional resets like the 68HC11. The microprocessor can force nRESET low when nRESET is pulled high by the SGM817xQ with no issues (Figure 5).

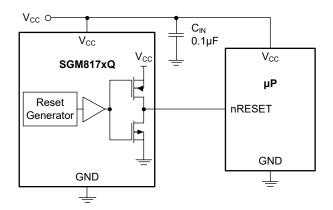


Figure 5. Interfacing to µP with Bidirectional Resets

Negative-Going V_{cc} Transient Immunity

The SGM817xQ has the ability to immune short time and negative V_{CC} transients or even glitches. It does not need to shut down the entire system. Resets are applied to the microprocessor during power-up, power-down and brownout conditions and not when an insignificant V_{CC} transient occurs.

A 0.1 μ F ceramic capacitor is recommended between the V_{CC} and GND pin to reduce the input supply noise.

Watchdog Input Current

The WDI input is internally driven by a buffer and series resistor from an internal counter chain stage of the watchdog. Therefore, when WDI is open, the watchdog timer is automatically cleared before timeout (by an internal low-high-low pulse).

To get the minimum WDI input current (minimum power loss), keep WDI low for the majority of the timeout period and send a high pulse at the first 7/8 of the timeout period for clearing the watchdog timer.

Watchdog Software Considerations

To have a more effective watchdog in software monitoring, rather than generating pulses by a code segment, set and reset the WDI input at different points of the program code. For example, set it in the main program and reset it in a periodic timing interrupt. For example, if WDI is toggled within an unwanted infinite loop, it will continuously reset watchdog as a normal condition and the processor is not reset.

An example of a watchdog flow is shown in Figure 6. The WDI is set high at the start of the program, and is set low at the start of every subroutine or loop, then is set high again when the program returns to the start. If the processor hangs in any subroutine, the WDI toggling will not occur and the watchdog will reset the processor and correct the situation.

The nRESET output may also be connected to an interrupt input of the μP for a corrective action if preferred.

Note that such watchdog control schemes may not be optimal if the total power consumption is critical as discussed in the Watchdog Input Current section.

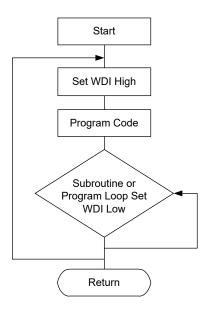


Figure 6. Watchdog Flow Diagram



REVISION HISTORY

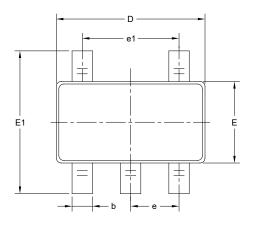
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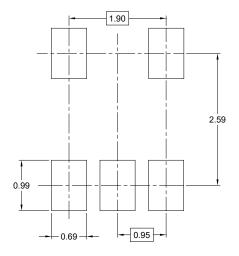
Changes from Original (AUGUST 2024) to REV.A

Changes from Original (AUGUST 2024) to REV.A	Page
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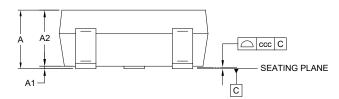


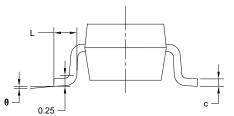
PACKAGE OUTLINE DIMENSIONS SOT-23-5





RECOMMENDED LAND PATTERN (Unit: mm)





Sympol	Di	Dimensions In Millimeters						
Symbol	MIN	NOM	МАХ					
A	-	-	1.450					
A1	0.000	-	0.150					
A2	0.900	-	1.300					
b	0.300	-	0.500					
С	0.080	-	0.220					
D	2.750	-	3.050					
E	1.450	1.450 -						
E1	2.600	-	3.000					
e		0.950 BSC						
e1		1.900 BSC						
L	0.300	-	0.600					
θ	0°	-	8°					
ССС	0.100							

NOTES:

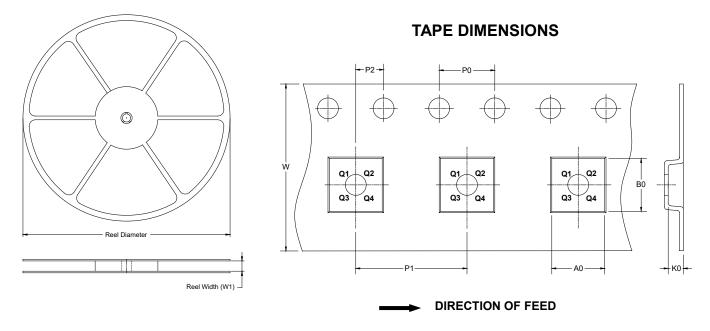
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The dimensions do not include mold flashes, protrusions or gate burrs.

3. Reference JEDEC MO-178.



TAPE AND REEL INFORMATION

REEL DIMENSIONS



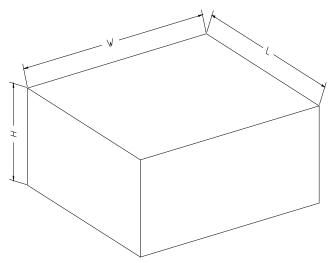
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KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT-23-5	7"	9.5	3.20	3.20	1.40	4.0	4.0	2.0	8.0	Q3



CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton	
7" (Option)	368	227	224	8	
7"	442	410	224	18	DD0002

